

100 →

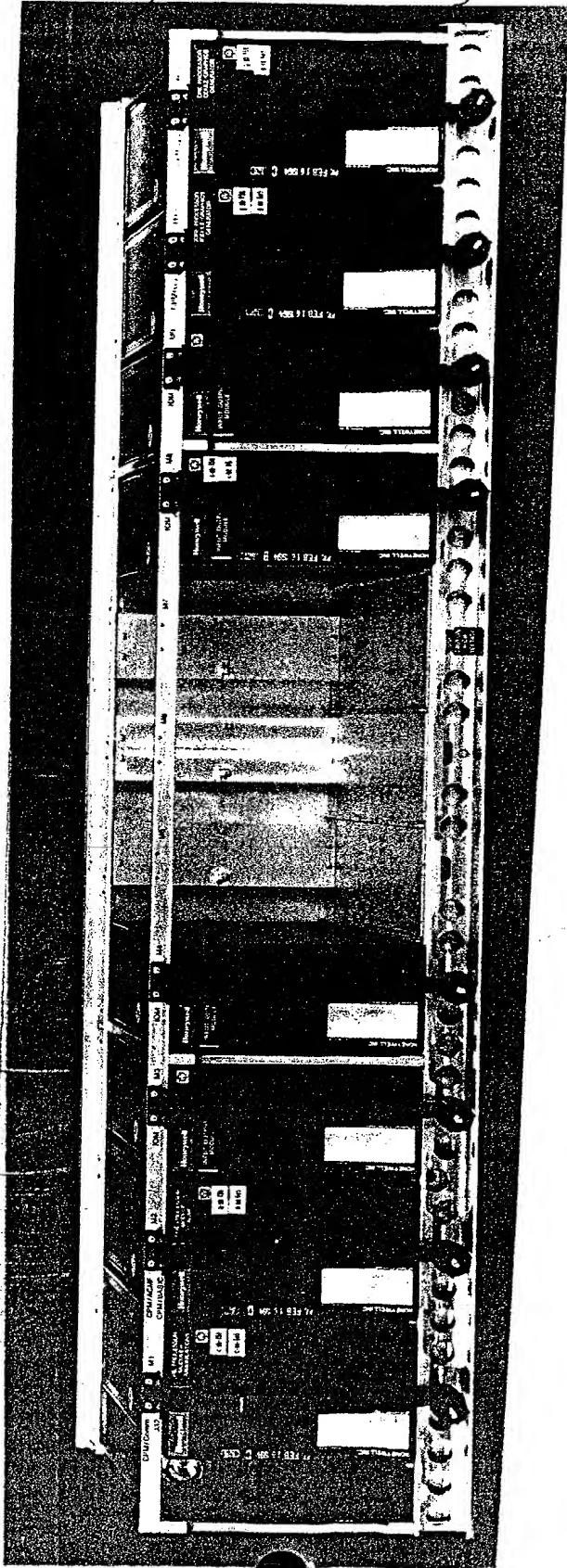


Figure 4 (Prior Art)



Figure 2 (Prior Art)

FIG. 1 is a perspective view of a prior art electronic device, showing a top surface with a grid of components and a side surface with a series of pins or connectors.



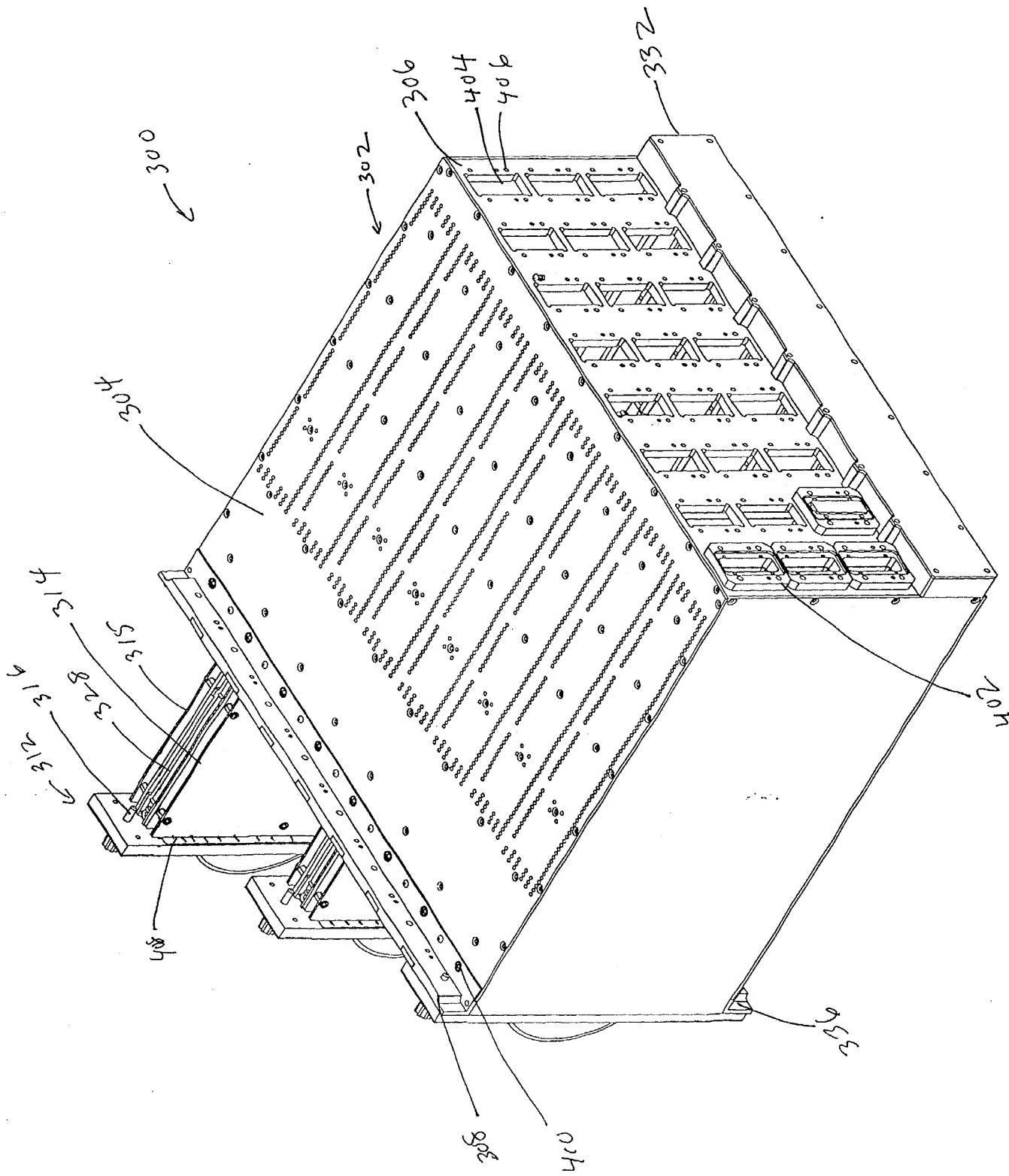


Figure 4

This drawing is a perspective view of the assembly 300 showing the top surface 304 and the right side 332. The assembly 300 is a rectangular structure with a top surface 304 and a right side 332. The top surface 304 is populated with numerous small circular features, possibly solder joints or vias. Along the right edge of the top surface 304, there is a series of rectangular components 404, each with a smaller rectangular feature 406 on its top surface. The right edge of the assembly is defined by a vertical wall 332. The front edge of the assembly is defined by a vertical wall 356. The bottom edge of the assembly is defined by a vertical wall 410. On the left side, there is a protruding structure 312, which includes a series of parallel lines 314 and 316, and a component 328. A bracket 315 is shown on the left side of the assembly. A component 408 is located at the bottom left corner of the assembly.



Sheet 1 of 2

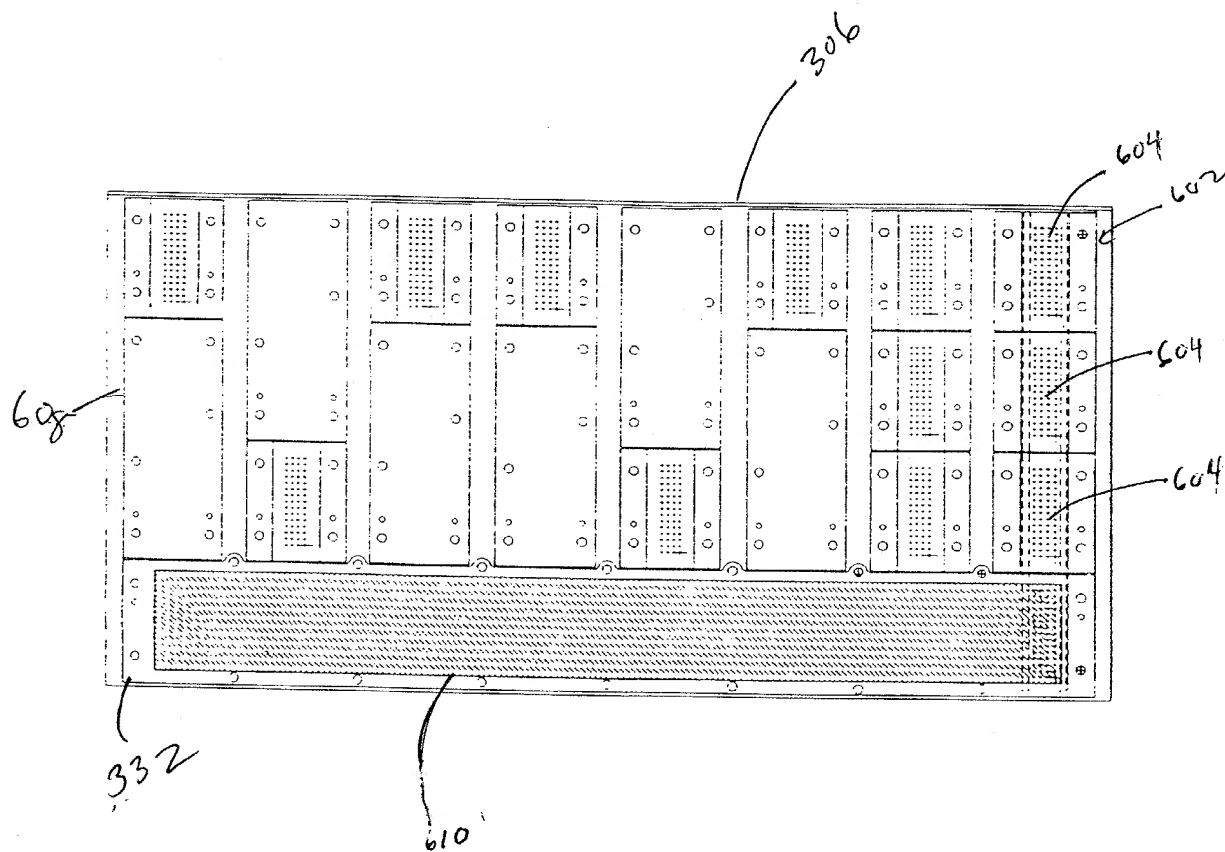


Figure 6

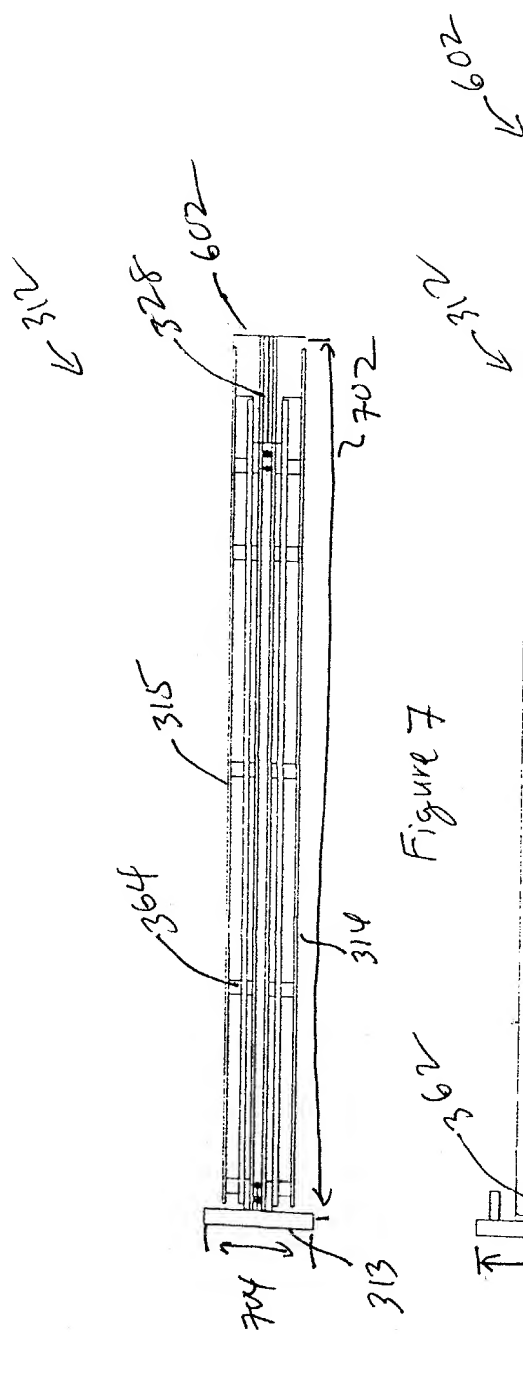


Figure 7

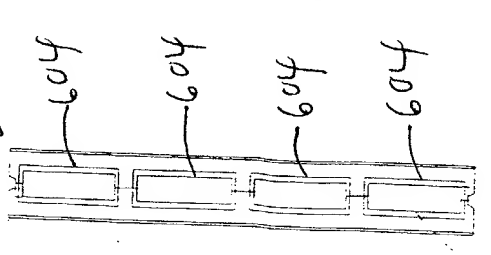


Figure 8

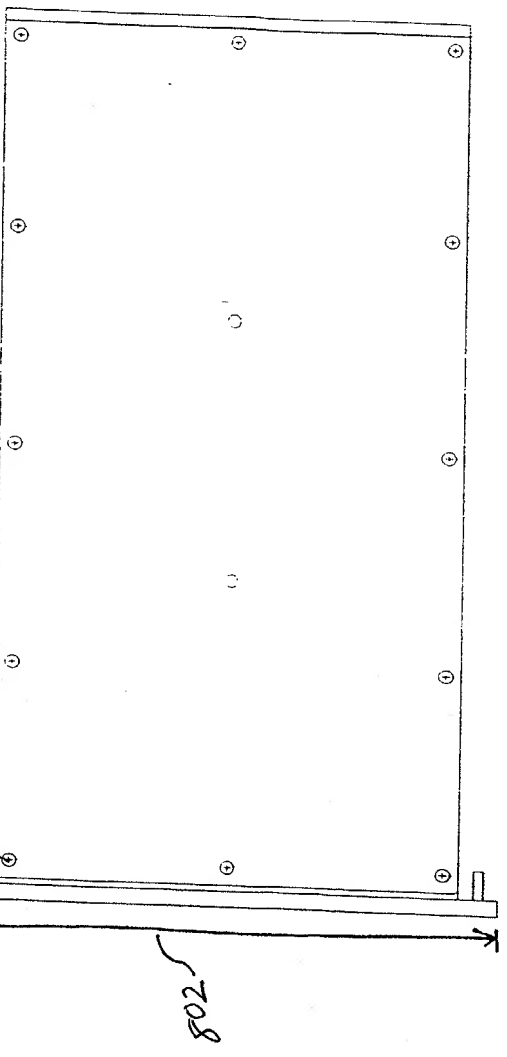


Figure 9

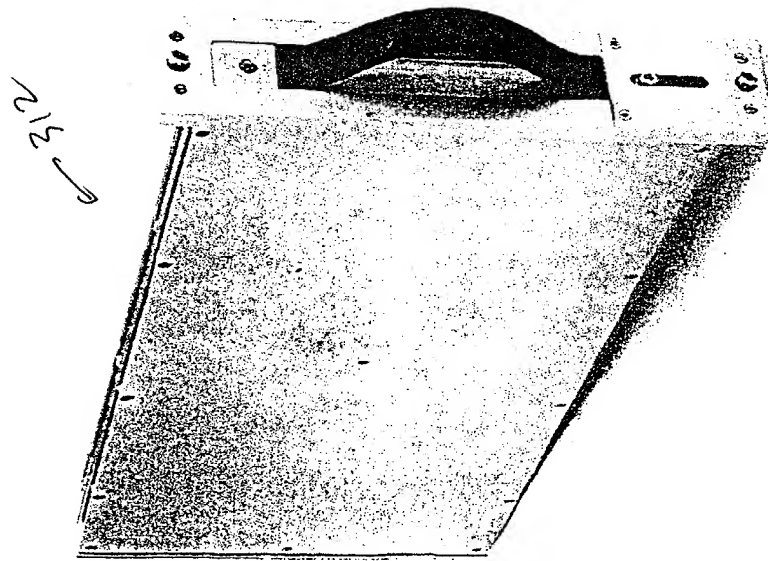


Figure 10

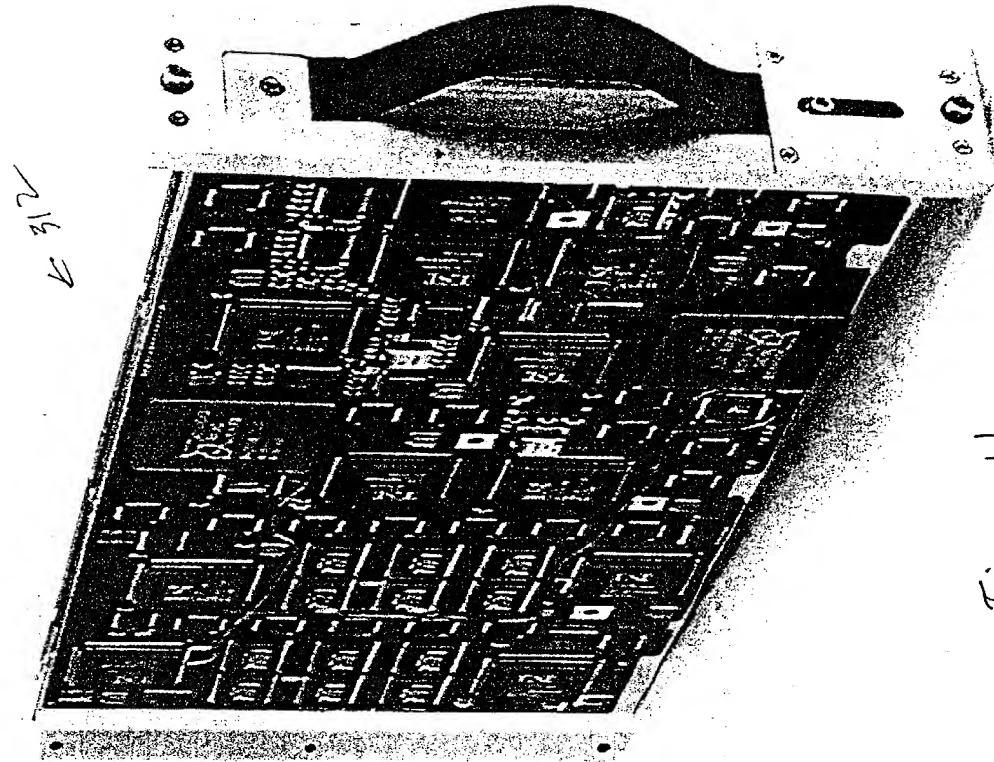


Figure 11

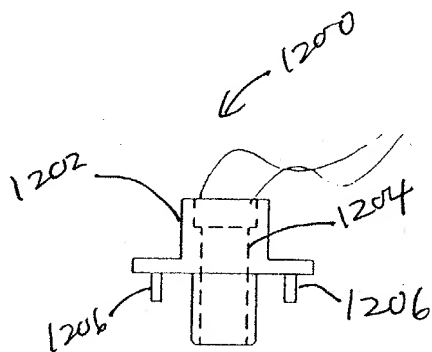


Figure 12

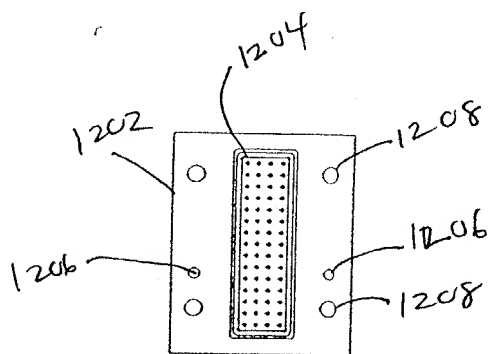


Figure 13

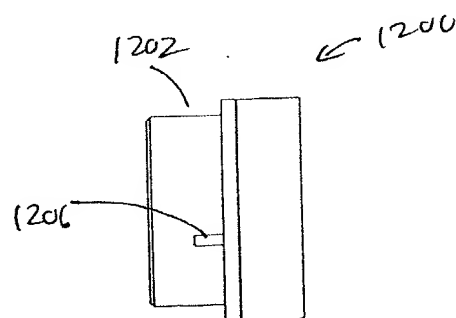


Figure 14



Figure 15

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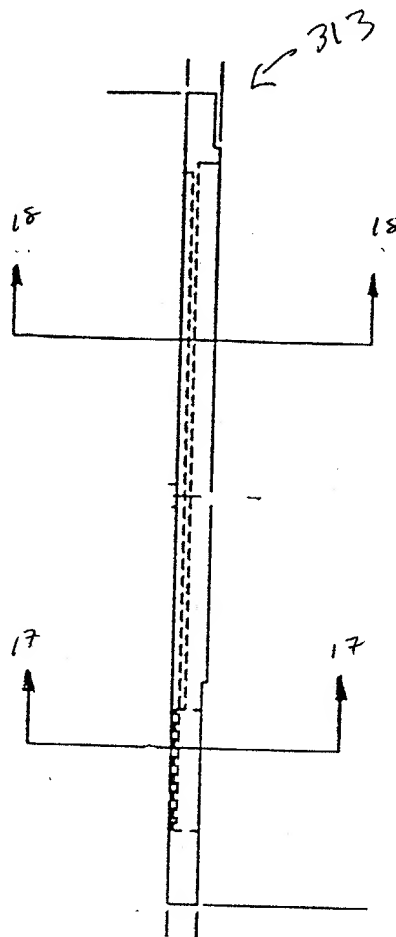


Figure 16

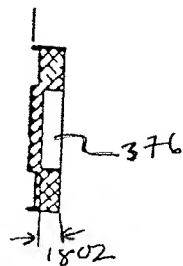


Figure 18

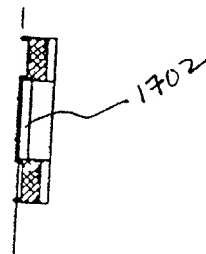


Figure 17

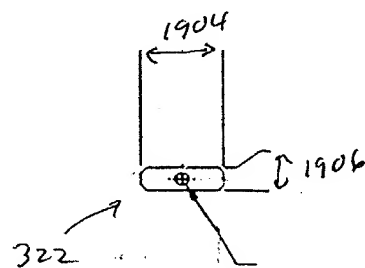


Figure 19

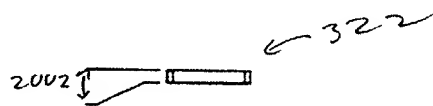


Figure 20

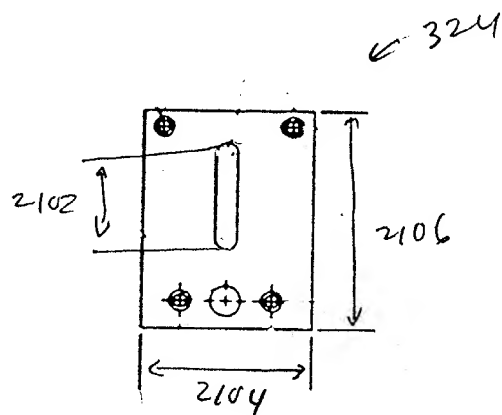


Figure 21

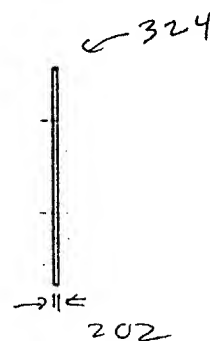


Figure 22

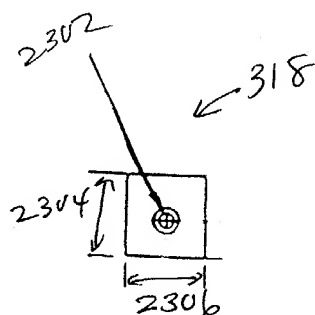


Figure 23

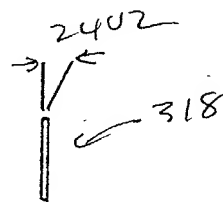


Figure 24

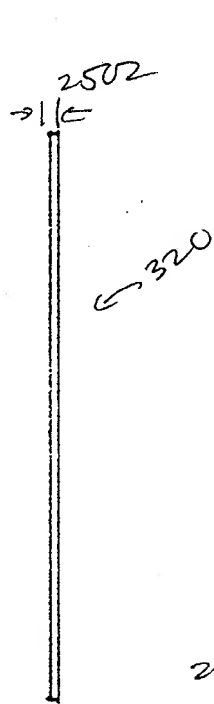


Figure 25

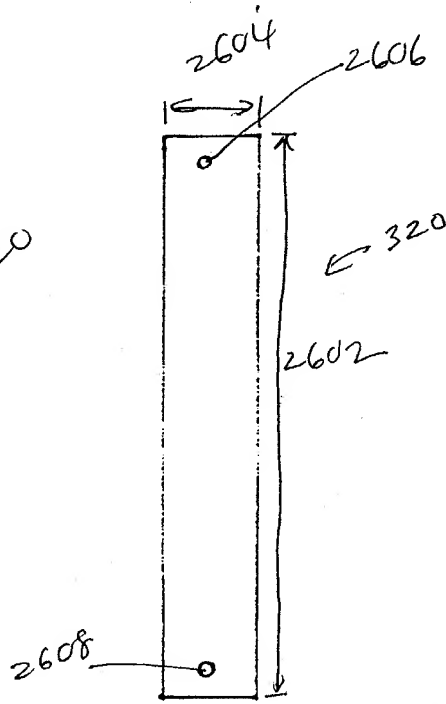


Figure 26